

TPA6132A2 EVM

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1 Introduction

This section provides an overview of the Texas Instruments (TI) TPA6132A2 DirectPath™ stereo headphone amplifier evaluation module (EVM). It includes a brief description of the module and a list of EVM specifications.

1.1 Description

The TPA6132A2 is a DirectPath™ stereo headphone amplifier capable of delivering 25 mW/Ch into 16 Ω and requires no output DC blocking capacitors.

The TPA6132A2 EVM is a complete, stand-alone audio board. It contains the TPA6132A2 QFN (RTE) DirectPath™ stereo headphone amplifier. All components are Pb-free.

1.2 EVM Specifications

Supply voltage range, V_{DD}	2.5 V to 5.5 V
Supply current, I_{DD}	0.5 A, maximum
Continuous output power, P_O , $V_{DD} = 5\text{ V}$, 16 Ω , THD+N = 1 %	25 mW

2 Operation

This section describes how to operate the TPA6132A2EVM.

2.1 Quick-Start List for Stand-Alone Operation

Use the following steps when operating the TPA6132A2EVM stand alone or when connecting the EVM into an existing circuit.

2.1.1 Power and Ground

1. Ensure that the external power sources are set to OFF.
2. Set the power supply voltage between 2.5 V and 5.5 V. When connecting the power supply to the EVM, first connect the ground connection to the GND connector, and then connect the positive supply to the V_{DD} connector. Verify that the connections are made to the correct banana jacks.

2.1.2 Inputs and Outputs

2.1.2.1 Audio

1. Ensure that the audio source is set to the minimum level.
2. Connect the audio source to the inputs, INL and INR. Shunt JP1 and JP2 for single-ended input.
3. Connect a headset or other load to the headphone jack.

2.1.2.2 Shutdown Controls

1. Shutdown is controlled by pushbutton S1. Press and hold S1 to place the TPA6132A2 in shutdown. Release S1 to reactivate the TPA6132A2.

2.1.3 Gain Setting

Set the gain of the TPA6132A2 at jumpers G0 and G1 according to the follow table:

Table 1. Gain Setting

G1	G0	GAIN (dB)
0	0	-6
0	1	0
1	0	3
1	1	6

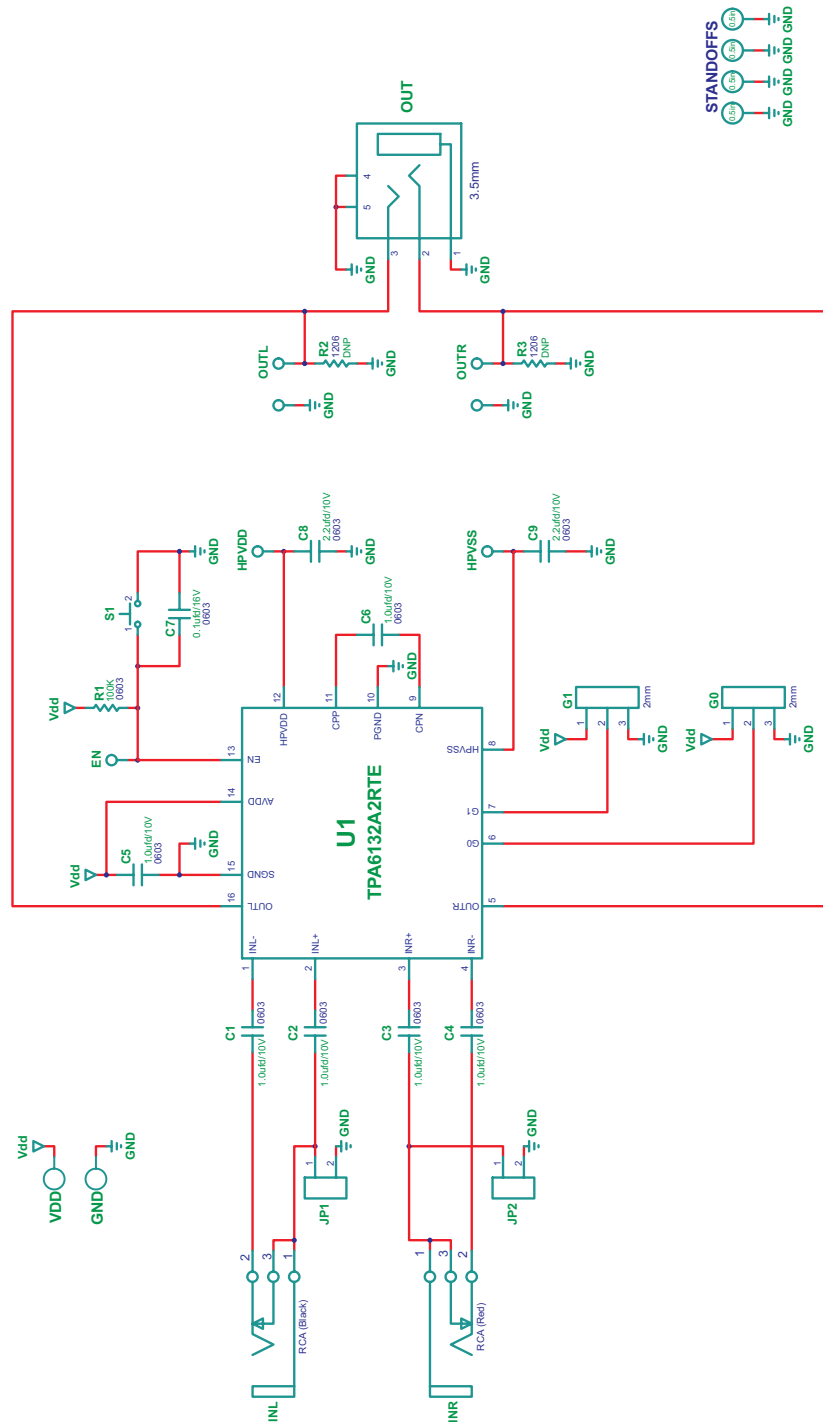
2.1.4 Power Up

1. Verify the correct connections as described in Sections 2.1.1 and 2.1.2.
2. Verify the correct voltage setting of the power supply and turn ON the power supply. Proper operation of the EVM should begin.
3. Adjust the audio signal source as needed.

3 Reference

This section includes the EVM schematic, board layout reference, and parts list.

3.1 TPA6132A2EVM Schematic



3.2 TPA6132A2EVM PCB Layers

Figure 1. Top Layer

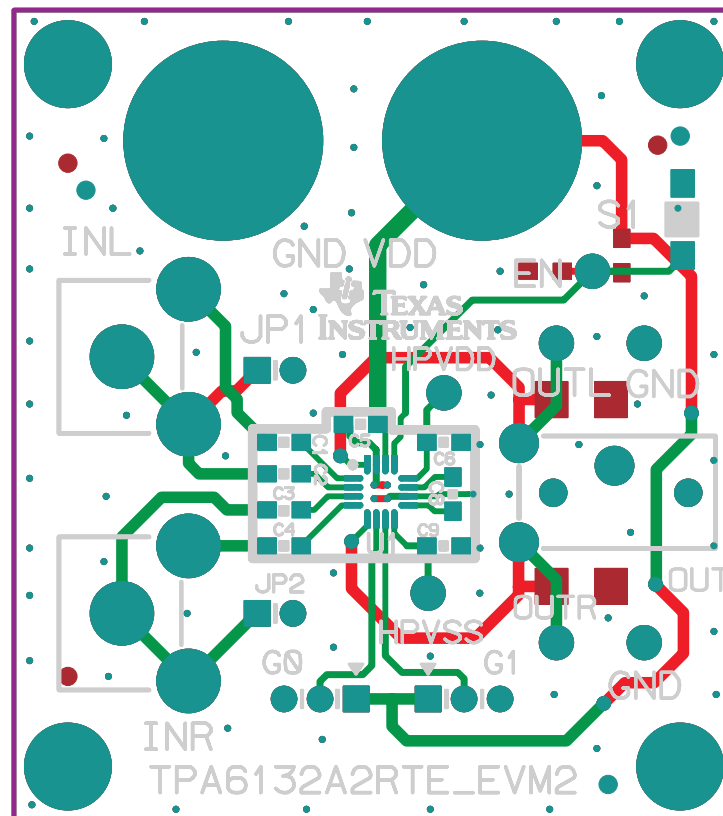
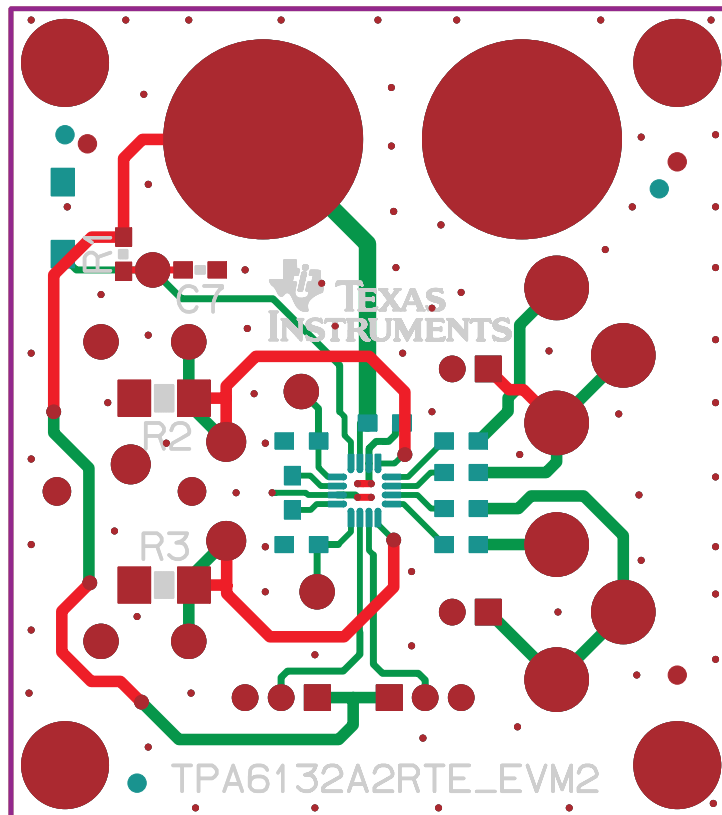


Figure 2. Bottom Layer



4 TPA6132A2EVM Bill of Materials

Table 2. TPA6132A2EVM Bill of Materials

Qty.	Reference	Description	SND Size	Manufacturer/ Part Number
6	C1, C2, C3, C4, C5, C6	Capacitor, ceramic, 1 μ F, 10 V, X5R	0603	Panasonic ECJ-1VB1A105K
1	C7	Capacitor, ceramic, 0.1 μ F, 16 V, X7R	0603	Panasonic ECJ-1VB1C104K
2	C8, C9	Capacitor, ceramic, 2.2 μ F, 10 V, X7R	0603	muRata GRM188R71A225KE15D
7	EN, GND, HPVDD, HPVSS, OUTL, OUTR	PC test point, white		Keystone 5002
2	GND,VDD	Binding post, 15a, uninsulated		Johnson Components 111-2223-001
2	G0,G1	Header, 3 pin, PCB 2.0mm ROHS		Norcomp 26630301RP2
4	G0, G1, JP1, JP2	Shunt, black au flash 2 mm		Norcomp 800-002-SP2-001
4	HW1, HW2, HW3, HW4	Hex nut, 4-40, zinc/steel		Building Fasteners HNZ440
4	HW1, HW2, HW3, HW4	Standoff, 4-40 threaded M/F 0.50 in. ALUM-HEX		Keystone Electronics 8401
2	INL, INR	Jack, RCA black, PCB-ra ROHS		Switchcraft PJRAN1X1U01X
4	JP1, JP2, G1, G0	Header, 2 pin, PCB 2 mm ROHS		Norcomp 26630201RP2
1	OUT	Jack, mini-stereo, PCB-ra, 3.5 mm ROHS		Kycon, Inc., P/N STX-3000
1	R1	Resistor, 100 k Ω , 1/10 W, 5%, SMD, ROHS	0603	Panasonic ERJ-3GEYJ104V
1	S1	Momentary switch, SMT-short, black tab, 160g		Panasonic EVQ-PPBA25
1	U1	DirectPath headphone amplifier	QFN 16 (RTE)	Texas Instruments TPA6132A2RTE

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of HPVSS - 0.3 V to HPVDD + 0.3 V and the output voltage range of HPVSS to HPVDD.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 85°C. The EVM is designed to operate properly with certain components above 85°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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